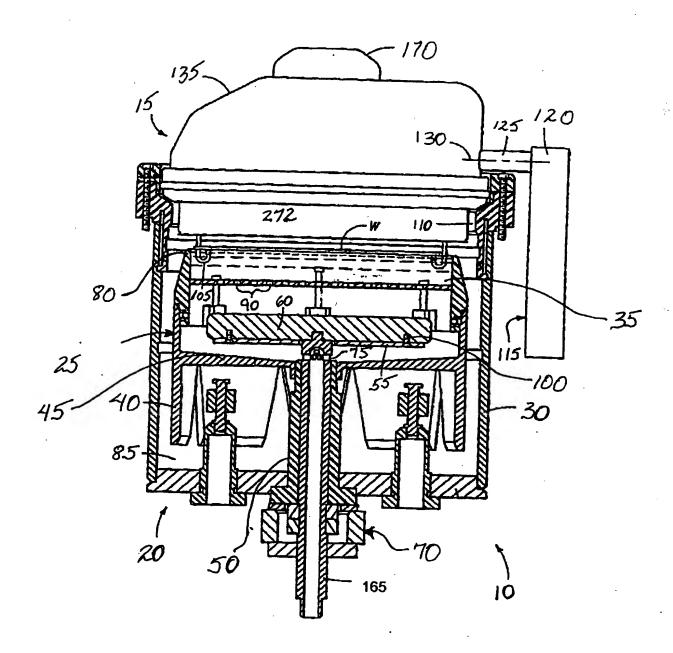
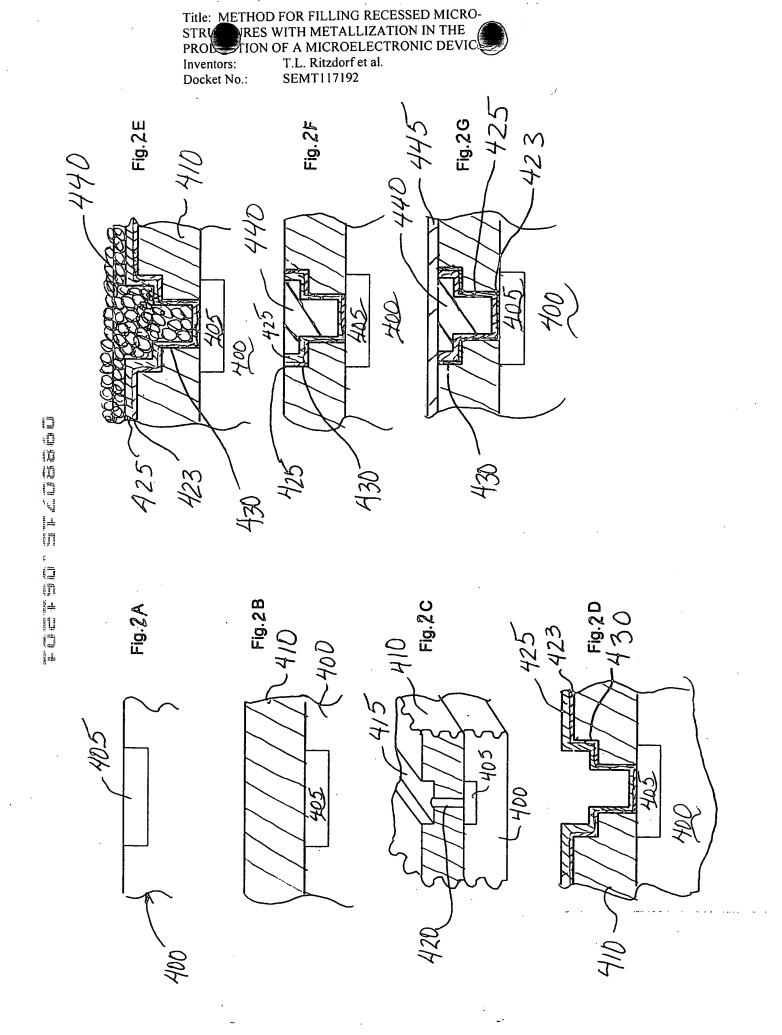
Title: METHOD FOR FILLING RECESSED MICRO-FRUCTURES WITH METALLIZATION IN E RODUCTION OF A MICROELECTRONIC VICE

Inventors: Docket No.: T.L. Ritzdorf et al. SEMT117192

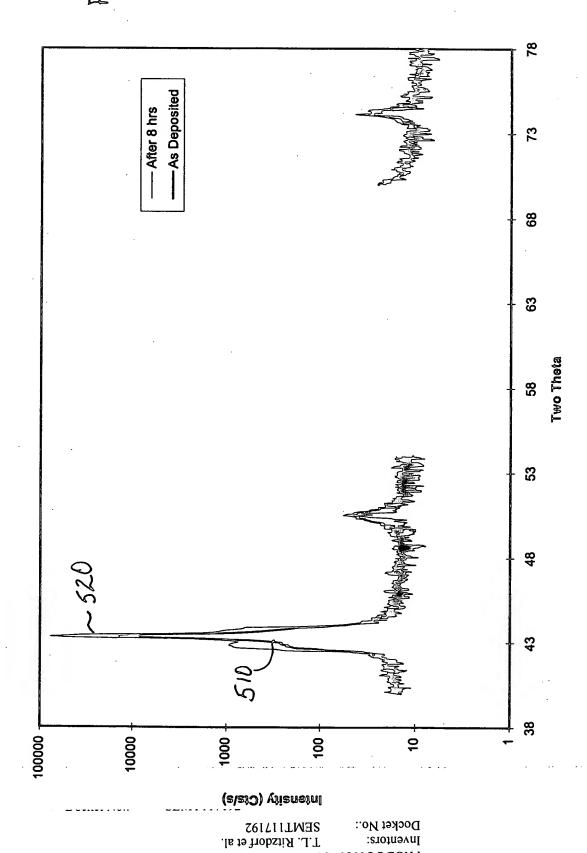
FIG. 1





Title: METHOD FOR FILLING RECESSED MICRO-

Two Theta Coupled Scan



PRODUCTION OF A MICROELECTRONIC DEVICE STRUCTURES WITH METALLIZATION IN THE Title: METHOD FOR FILLING RECESSED MICRO-

Inventors:

Docket No.: Inventors:

PRODUCTION OF A MICROELECTRONIC DEVICE STRUCTURES WITH METALLIZATION IN THE Litle: METHOD FOR FILLING RECESSED MICRO-